

Investigation of giant step-bunching occurrence during graphene growth on 4H-SiC (0001) in low pressure Ar-H₂ mix gases

Hrich Haitham¹

Matthieu Paillet¹, Jean-Manuel Decams², Sylvie Contreras¹, Périne Landois¹

¹ Laboratoire Charles Coulomb, UMR 5221, Univ Montpellier, CNRS, Montpellier, France

² Annealsys, 139 rue des Walkyries, 34000 Montpellier, France

Haitham.hrich@umontpellier.fr

Our group have recently optimized a reproducible and controlled growth process of a monolayer graphene on SiC (0001) at low Ar pressure (10mbar) [1]. We highlight that such process is compatible with electronic applications hence no transfer is needed. The graphene samples obtained using this process have a mobility up to 2000 cm²V⁻¹s⁻¹, at room temperature, which corresponds to the state of the art on similar substrates [2]. One way to enhance the graphene's mobility is by reducing the steps density on the surface. These steps with different surface energies have different step velocities and therefore the steps are preferable to be bunched together aiming to minimize the total surface energy during the thermal treatment [3]. This step bunching often occurs during epitaxial growth of graphene on SiC. The height and width of the steps depend on various factors, such as, polytype of SiC, miscut angle [4] and growth conditions [5]. In this study, we have investigated the etching of 4H-SiC (0001) by H₂ and the occurrence of giant step bunching (GSB) in Ar-H₂ mix gases system at low pressure (10 mbar). The first results show a clear effect of H₂ on the formation of giant steps. The surface of the samples grown under Ar-H₂ environment have a homogeneous distribution of well-aligned steps with terraces width up to 20 μm (figure 1).

References

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Figure

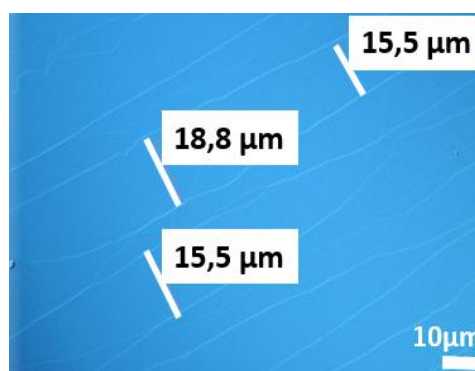


Figure 1: Typical optical image of 4H-SiC sample, after thermal annealing under Ar-H₂ environment, showing large steps. To obtain this image, differential interference contrast (DIC) was used to enhance step edges.